## MC74HC259A

## 8-Bit Addressable Latch 1-of-8 Decoder

## High-Performance Silicon-Gate CMOS

The MC74HC259A is identical in pinout to the LS259. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs.

The HC259A has four modes of operation as shown in the mode selection table. In the addressable latch mode, the data on Data In is written into the addressed latch. The addressed latch follows the data input with all non-addressed latches remaining in their previous states. In the memory mode, all latches remain in their previous state and are unaffected by the Data or Address inputs. In the one-of-eight decoding or demultiplexing mode, the addressed output follows the state of Data In with all other outputs in the LOW state. In the Reset mode all outputs are LOW and unaffected by the address and data inputs. When operating the HC259A as an addressable latch, changing more than one bit of the address could impose a transient wrong address. Therefore, this should only be done while in the memory mode.

## Features

- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2 to 6 V
- Low Input Current: $1 \mu \mathrm{~A}$
- High Noise Immunity Characteristic of CMOS Devices
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are $\mathrm{Pb}-$ Free, Halogen Free and are RoHS Compliant

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## PIN ASSIGNMENT



MODE SELECTION TABLE

| Enable | Reset | Mode |
| :---: | :---: | :---: |
| L | H | Addressable Latch |
| H | H | Memory |
| L | L | 8-Line Demultiplexer |
| H | L | Reset |

ORDERING INFORMATION
See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.


Figure 1. Logic Diagram

MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | DC Supply Voltage (Referenced to GND) | -0.5 to +7.0 | V |
| $\mathrm{~V}_{\text {in }}$ | DC Input Voltage (Referenced to GND) | -0.5 to $\mathrm{V}_{\mathrm{CC}}+0.5$ | V |
| $\mathrm{~V}_{\text {out }}$ | DC Output Voltage (Referenced to GND) | -0.5 to $\mathrm{V}_{\mathrm{CC}}+0.5$ | V |
| $\mathrm{I}_{\text {in }}$ | DC Input Current, per Pin | $\pm 20$ | mA |
| $\mathrm{I}_{\text {out }}$ | DC Output Current, per Pin | $\pm 25$ | mA |
| $\mathrm{I}_{\mathrm{CC}}$ | DC Supply Current, $\mathrm{V}_{\mathrm{CC}}$ and GND Pins | $\pm 50$ | mA |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation in Still Air, $\quad$SOIC Package <br> TSSOP Package | 500 | mW |
|  |  | 450 |  |
| $\mathrm{~T}_{\text {stg }}$ | Storage Temperature | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

## RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Max | Unit |
| :---: | :--- | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | DC Supply Voltage (Referenced to GND) | 2.0 | 6.0 | V |
| $\mathrm{~V}_{\text {in }}, \mathrm{V}_{\text {out }}$ | DC Input Voltage, Output Voltage (Referenced to GND) | 0 | $\mathrm{~V}_{\mathrm{CC}}$ | V |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Temperature, All Package Types | -55 | +125 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{t}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$ | Input Rise and Fall Time | $\mathrm{V}_{\mathrm{CC}}=2.0 \mathrm{~V}$ | 0 | 1000 |
|  | (Figure 2) | ns |  |  |
|  |  | $\mathrm{V}_{\mathrm{CC}}=3.0 \mathrm{~V}$ | 0 | 600 |
|  |  | $\mathrm{~V}_{\mathrm{CC}}=4.5 \mathrm{~V}$ | 0 | 500 |
|  |  | $\mathrm{~V}_{\mathrm{CC}}=6.0 \mathrm{~V}$ | 0 | 400 |
|  |  |  |  |  |
|  |  |  |  |  |

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, $\mathrm{V}_{\text {in }}$ and $V_{\text {out }}$ should be constrained to the range $G N D \leq\left(\mathrm{V}_{\text {in }}\right.$ or $\left.\mathrm{V}_{\text {out }}\right) \leq \mathrm{V}_{\mathrm{CC}}$. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or $\mathrm{V}_{\mathrm{CC}}$ ). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

| Symbol | Parameter | Test Conditions | $\underset{\mathbf{V}}{\mathbf{v}_{\mathrm{cc}}}$ | Guaranteed Limit |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $\begin{gathered} -55 \text { to } \\ 25^{\circ} \mathrm{C} \end{gathered}$ | $\leq 85^{\circ} \mathrm{C}$ | $\leq 125^{\circ} \mathrm{C}$ |  |
| $\mathrm{V}_{\mathrm{IH}}$ | Minimum High-Level Input Voltage | $\begin{aligned} & \mathrm{V}_{\text {out }}=0.1 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{CC}}-0.1 \mathrm{~V} \\ & \mid \mathrm{l}_{\text {out }} \leq 20 \mu \mathrm{~A} \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{gathered} \hline 1.5 \\ 2.1 \\ 3.15 \\ 4.2 \end{gathered}$ | $\begin{gathered} 1.5 \\ 2.1 \\ 3.15 \\ 4.2 \end{gathered}$ | $\begin{gathered} 1.5 \\ 2.1 \\ 3.15 \\ 4.2 \end{gathered}$ | V |
| VIL | Maximum Low-Level Input Voltage | $\begin{aligned} & \mathrm{V}_{\text {out }}=0.1 \mathrm{~V} \text { or } \mathrm{V}_{\mathrm{CC}}-0.1 \mathrm{~V} \\ & \mid \mathrm{l}_{\text {out }} \leq 20 \mu \mathrm{~A} \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{gathered} \hline 0.5 \\ 0.9 \\ 1.35 \\ 1.80 \end{gathered}$ | $\begin{gathered} \hline 0.5 \\ 0.9 \\ 1.35 \\ 1.80 \end{gathered}$ | $\begin{gathered} \hline 0.5 \\ 0.9 \\ 1.35 \\ 1.80 \end{gathered}$ | V |
| $\mathrm{V}_{\mathrm{OH}}$ | Minimum High-Level Output Voltage | $\begin{aligned} & \mathrm{V}_{\text {in }}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} \\ & \mid l_{\text {out }} \leq 20 \mu \mathrm{~A} \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 1.9 \\ & 4.4 \\ & 5.9 \end{aligned}$ | $\begin{aligned} & 1.9 \\ & 4.4 \\ & 5.9 \end{aligned}$ | $\begin{aligned} & 1.9 \\ & 4.4 \\ & 5.9 \end{aligned}$ | V |
|  |  | $\begin{array}{\|ll} \hline \mathrm{V}_{\text {in }}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} & \begin{array}{l} \mid \\|_{\text {out }} \leq 2.4 \mathrm{~mA} \\ \\ \\ \\ \\ l_{\text {out }} \mid \leq 4.0 \mathrm{~mA} \\ \left\|\left.\right\|_{\text {out }}\right\| \leq 5.2 \mathrm{~mA} \end{array} \end{array}$ | $\begin{aligned} & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 2.48 \\ & 3.98 \\ & 5.48 \end{aligned}$ | $\begin{aligned} & 2.34 \\ & 3.84 \\ & 5.34 \end{aligned}$ | $\begin{aligned} & 2.20 \\ & 3.70 \\ & 5.20 \end{aligned}$ |  |
| $\mathrm{V}_{\text {OL }}$ | Maximum Low-Level Output Voltage | $\begin{aligned} & \mathrm{V}_{\text {in }}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} \\ & \mid \mathrm{l}_{\text {outt }} \leq 20 \mu \mathrm{~A} \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 0.1 \\ & 0.1 \\ & 0.1 \end{aligned}$ | $\begin{aligned} & \hline 0.1 \\ & 0.1 \\ & 0.1 \end{aligned}$ | $\begin{aligned} & \hline 0.1 \\ & 0.1 \\ & 0.1 \end{aligned}$ | V |
|  |  | $\begin{array}{\|ll} \hline \mathrm{V}_{\text {in }}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} & \begin{array}{l} \mid \\|_{\text {out }} \leq 2.4 \mathrm{~mA} \\ \\ \\ \\ \\ \\ \\ \\ l_{\text {out }} \mid \leq 4.0 \mathrm{~mA} \end{array} \leq 5.2 \mathrm{~mA} \end{array}$ | $\begin{aligned} & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 0.26 \\ & 0.26 \\ & 0.26 \end{aligned}$ | $\begin{aligned} & 0.33 \\ & 0.33 \\ & 0.33 \end{aligned}$ | $\begin{aligned} & 0.40 \\ & 0.40 \\ & 0.40 \end{aligned}$ |  |
| $\mathrm{l}_{\text {in }}$ | Maximum Input Leakage Current | $\mathrm{V}_{\text {in }}=\mathrm{V}_{\text {cc }}$ or GND | 6.0 | $\pm 0.1$ | $\pm 1.0$ | $\pm 1.0$ | $\mu \mathrm{A}$ |
| Icc | Maximum Quiescent Supply Current (per Package) | $\begin{aligned} & \mathrm{V}_{\text {in }}=\mathrm{V}_{\mathrm{CC}} \text { or GND } \\ & \mathrm{I}_{\text {out }}=0 \mu \mathrm{~A} \end{aligned}$ | 6.0 | 4 | 40 | 160 | $\mu \mathrm{A}$ |

AC ELECTRICAL CHARACTERISTICS ( $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$, $\left.\operatorname{lnput} \mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=6 \mathrm{~ns}\right)$

| Symbol | Parameter | $\underset{\mathrm{V}}{\mathrm{v}_{\mathrm{cc}}}$ | Guaranteed Limit |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} -55 \text { to } \\ 25^{\circ} \mathrm{C} \end{gathered}$ | $\leq 85^{\circ} \mathrm{C}$ | $\leq 125^{\circ} \mathrm{C}$ |  |
| $\begin{aligned} & \text { tpLH, } \\ & \mathrm{t}_{\text {PH }} \end{aligned}$ | Maximum Propagation Delay, Data to Output (Figures 2 and 7) | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{gathered} \hline 125 \\ 45 \\ 32 \\ 25 \end{gathered}$ | $\begin{aligned} & 160 \\ & 60 \\ & 32 \\ & 28 \end{aligned}$ | $\begin{aligned} & 175 \\ & 70 \\ & 42 \\ & 33 \end{aligned}$ | ns |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{PLH}}, \\ & \mathrm{t}_{\text {PHL }} \end{aligned}$ | Maximum Propagation Delay, Address Select to Output (Figures 3 and 7) | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 150 \\ & 60 \\ & 32 \\ & 28 \end{aligned}$ | $\begin{aligned} & 175 \\ & 70 \\ & 40 \\ & 30 \end{aligned}$ | $\begin{aligned} & 200 \\ & 80 \\ & 45 \\ & 35 \end{aligned}$ | ns |
| $\begin{aligned} & \mathrm{t} \mathrm{tPLH}, \\ & \mathrm{t}_{\mathrm{PHL}} \end{aligned}$ | Maximum Propagation Delay, Enable to Output (Figures 4 and 7) | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 150 \\ & 60 \\ & 32 \\ & 28 \end{aligned}$ | $\begin{aligned} & 175 \\ & 70 \\ & 40 \\ & 30 \end{aligned}$ | $\begin{aligned} & 200 \\ & 80 \\ & 45 \\ & 35 \end{aligned}$ | ns |
| $\mathrm{t}_{\text {PHL }}$ | Maximum Propagation Delay, Reset to Output (Figures 5 and 7) | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{gathered} \hline 110 \\ 36 \\ 22 \\ 19 \end{gathered}$ | $\begin{gathered} \hline 125 \\ 45 \\ 26 \\ 23 \end{gathered}$ | $\begin{gathered} \hline 160 \\ 60 \\ 32 \\ 28 \end{gathered}$ | ns |
| $\begin{aligned} & \mathrm{t}_{\mathrm{TLLH}}, \\ & \mathrm{t}_{\mathrm{TH}}, \end{aligned}$ | Maximum Output Transition Time, Any Output (Figures 2 and 7) | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 75 \\ & 27 \\ & 15 \\ & 13 \end{aligned}$ | $\begin{aligned} & 95 \\ & 32 \\ & 19 \\ & 16 \end{aligned}$ | $\begin{aligned} & \hline 110 \\ & 36 \\ & 22 \\ & 19 \end{aligned}$ | ns |
| $\mathrm{C}_{\text {in }}$ | Maximum Input Capacitance | - | 10 | 10 | 10 | pF |


| $\mathrm{C}_{\text {PD }}$ |  | Typical @ $25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{cc}}=5.0 \mathrm{~V}$ | pF |
| :---: | :---: | :---: | :---: |
|  | Power Dissipation Capacitance (Per Package) | 30 |  |

TIMING REQUIREMENTS (Input $t_{r}=t_{f}=6 \mathrm{~ns}$ )

| Symbol | Parameter | $\underset{\mathbf{V}}{\mathbf{v}_{\mathrm{cc}}}$ | Guaranteed Limit |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | $\begin{gathered} -55 \text { to } \\ 25^{\circ} \mathrm{C} \end{gathered}$ | $\leq 85^{\circ} \mathrm{C}$ | $\leq 125^{\circ} \mathrm{C}$ |  |
| $\mathrm{t}_{\text {su }}$ | Minimum Setup Time, Address or Data to Enable (Figure 6) | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 75 \\ & 30 \\ & 15 \\ & 13 \end{aligned}$ | $\begin{aligned} & 95 \\ & 40 \\ & 19 \\ & 16 \end{aligned}$ | $\begin{gathered} \hline 110 \\ 55 \\ 22 \\ 19 \end{gathered}$ | ns |
| $t_{\text {h }}$ | Minimum Hold Time, Enable to Address or Data (Figure 6) | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & \hline 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | $\begin{aligned} & \hline 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | $\begin{aligned} & \hline 1 \\ & 1 \\ & 1 \\ & 1 \end{aligned}$ | ns |
| $\mathrm{t}_{\text {w }}$ | Minimum Pulse Width, Reset or Enable (Figure 4 or 5) | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{aligned} & 70 \\ & 27 \\ & 15 \\ & 13 \end{aligned}$ | $\begin{aligned} & 90 \\ & 32 \\ & 19 \\ & 16 \end{aligned}$ | $\begin{gathered} 100 \\ 36 \\ 22 \\ 19 \end{gathered}$ | ns |
| $\mathrm{tr}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$ | Maximum Input Rise and Fall Times (Figure 2) | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \\ & 6.0 \end{aligned}$ | $\begin{gathered} \hline 1000 \\ 800 \\ 500 \\ 400 \end{gathered}$ | $\begin{aligned} & \hline 1000 \\ & 800 \\ & 500 \\ & 400 \end{aligned}$ | $\begin{gathered} 1000 \\ 800 \\ 500 \\ 400 \end{gathered}$ | ns |

## SWITCHING WAVEFORMS



Figure 2.


Figure 4.


Figure 6.

*Includes all probe and jig capacitance

Figure 7. Test Circuit


Figure 8. Expanded Logic Diagram

ORDERING INFORMATION

| Device | Package | Shipping ${ }^{\dagger}$ |
| :--- | :--- | :---: |
| MC74HC259ADG | SOIC-16 <br> (Pb-Free) | 48 Units / Rail |
| MC74HC259ADR2G | SOIC-16 <br> (Pb-Free) | $2500 /$ Tape \& Reel |
| MC74HC259ADTR2G | TSSOP-16 <br> (Pb-Free) | $2500 /$ Tape \& Reel |
| MC74HC259ADTG | TSSOP-16 <br> (Pb-Free) | 96 Units / Rail |
| NLVHC259ADR2G* | SOIC-16 <br> (Pb-Free) | $2500 /$ Tape \& Reel |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable

## PACKAGE DIMENSIONS

SOIC-16
CASE 751B-05


SOLDERING FOOTPRINT*

*For additional information on our $\mathrm{Pb}-F r e e$ strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## MC74HC259A

## PACKAGE DIMENSIONS


*For additional information on our $\mathrm{Pb}-$ Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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